

Microfocus X-ray Sources Catalog

Hamamatsu Photonics' Microfocus X-ray Sources for High-Resolution 2D and 3D Imaging in Non-Destructive Testing



Enhancing Industrial X-ray Imaging

Hamamatsu Photonics is a global leading manufacturer specializing in photonic technologies, offering a range of X-ray sensors and imaging solutions. Our product lineup includes Microfocus X-ray sources (page 6), photodiode arrays, and advanced imaging systems such as flat panel sensors, TDI and line scan cameras (page 7) packaged in robust enclosures and ready for integration into production lines.

These products are designed for diverse industrial non-destructive testing applications, including micro-computed tomography, lithium-ion battery inspection, structural material, semiconductor, and PCB analysis (page 5).

Hamamatsu's commitment to innovation and quality ensures that its X-ray imaging solutions deliver high sensitivity, resolution, and reliability to meet the rigorous needs of the X-ray market. Visit one of our local European offices or ask for our testing facilities to evaluate your needed application (page 8).

The Microfocus X-ray Sources Series

Hamamatsu offers a comprehensive lineup of Microfocus X-ray (MFX) sources tailored to meet diverse application needs. Featuring a small focal spot size, these sources minimize image blurring and deliver sharp, high-definition results.

Designed to operate between 20 and 300 kV, MFX are specifically developed for 2D and 3D non-destructive testing. The MFX series is available in both sealed and open configurations, making it ideal for a wide range of factory production applications:

Sealed Types

Compact and easy to integrate into systems. These sources are well-suited for applications requiring a small footprint and straightforward installation. These models eliminate the need for high-voltage cables and periodic maintenance, enhancing usability.





Full product range available p.6 and on our website www.hamamatsu.com



Open Types

Featuring high tube voltage and high-resolution characteristics, open type sources enable applications that demand the highest imaging precision. The highvoltage power supply is embedded, and they do not need maintenance on the high-voltage cable. They require additional equipment, such as a vacuum pump, and periodic maintenance.



The Microfocus X-ray Sources Characteristics

Tube voltage

Tube voltage

150 kV

Tube voltage X-ray transmission

As the X-ray energy increases with the increase in tube voltage, the X-ray transmission to the object also increases. A high-contrast X-ray image can be obtained by setting a tube voltage value suitable for the object.

Focal spot size X-ray image transition

The focal spot size is directly related to the resolution of images. The larger the focal spot size is, the larger the blurry area in images (penumbra) becomes at high magnification imaging. In contrast, the smaller focal spot size enables less blurry X-ray images.



Geometric magnification

X-ray image magnification

When FDD is set to a constant value, the shorter the FOD is, the higher the geometric magnification calculated by FDD/FOD becomes.

FOD focus to object distance Distance from X-ray focal spot to object.

FDD focus to detector distance Distance from X-ray focal spot to X-ray detector.



Tube current / output X-ray image brightness

With the tube current value increased, the X-ray dose also increases, and a brighter X-ray image can be obtained. When you inspect an object, the higher the tube current and output are, the shorter the imaging time and the faster the inspection throughput become.

X-ray radiation angle Imaging area

The wide radiation angle reduces the irradiation distance and enables imaging of large objects. It also enables 3D shape observation by imaging from an oblique direction. Select the optimum X-ray radiation angle according to your application and object.

Narrow angle radiatio

X-ray image

Tube curren

Tube curren

Maintainability

The sealed type is designed so that the X-ray generator is sealed in a vacuum tube. There is no need for periodic maintenance by the customer. The open type requires the customer to replace the cathode/target during periodic maintenance. It can be used continuously for a long period of time and contributes to downtime reduction.



Main Applications



Micro Computed-Tomography

A non-destructive 3D imaging technique that utilizes X-rays to visualize the internal structure of objects with high resolution. Micro-CT is instrumental in analyzing complex internal geometries, detecting defects, and conducting precise measurements across various industries, including materials science and manufacturing.









Lithium-ion Battery Inspection (LiB)

An advanced in-line imaging method ensuring LiB quality by detecting minute foreign particles and defects that could lead to heat generation or ignition. X-ray imaging facilitates the examination of internal layers, verifying uniformity and correct positioning, which are crucial for battery performance and safety.

Material Analysis

In general, for material or product inspection, Microfocus X-ray sources are used to inspect parts in industries like aerospace, automotive and telecommunication. They can detect flaws that might affect the performance, durability, or safety of these components. Examples are typically die-cast, cable and rubber/plastic items inspection. Material inspection can include a variety of different applications, among which we can list geological samples inspection.

Semiconductor Analysis

High-precision, non-destructive inspection methods that ensure reliability in semiconductor products. X-ray imaging techniques, such as microfocus X-ray computed tomography, detect internal defects like voids and cracks, contributing to improved product quality and performance.

Printed Circuit Board Analysis

High-resolution inspection of components and connections to ensure safety and functionality. Automated X-ray inspection (AXI) systems detect solder joint defects, misalignments, and other anomalies in PCBs, facilitating process optimization and anomaly detection in electronics manufacturing.





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Latest Microfocus X-ray Sources

Part no.	Tube Voltage	Tube Current	Max. Output	X-ray Focal Spot Size	X-ray Beam Angle	Focus to Object Distance (FOD)	Applications**	
Sealed Type								
L9181-02 ^[1]	40 kV to 130 kV	10 µA to 300 µA	39 W	5 µm at 4 W	45 degrees	13 mm	• •	
L9181-05 ^[1]	40 kV to 130 kV	10 µA to 300 µA	39 W	16 µm to 50 µm	100 degrees	13 mm	= + –	
L9421-02 ^[2]	20 kV to 90 kV	0 µA to 200 µA (8 W Max.)	8 W	7 µm to 80 µm	39 degrees	9.5 mm	• •	
L10101	40 kV to 100 kV	10 µA to 200 µA	20 W	5 µm to 30 µm (5 µm at 4 W)	42 degrees	6.8 mm	•	
L10321	40 kV to 100 kV	10 µA to 200 µA	20 W	5 µm to 30 µm (5 µm at 4 W)	118 degrees	7.3 mm	•	
L10951	40 kV to 110 kV	10 μA to 800 μA (50 W Max.)	50 W	15 µm to 80 µm	62 degrees	16.8 mm	•	
L12161-07 ^[3]	40 kV to 150 kV	10 μA to 500 μA (30 W Max.)	75 W	5 µm (at 4 W)	43 degrees	17 mm	•	
L12531-01 ^[4]	40 kV to 110 kV	0 µA to 200 µA	16 W	Min. resolution 2 µm	120 degrees	1 mm	• - •	
L14351-01	40 kV to 180 kV	0 µA to 500 µA	90 W	20 µm to 200 µm	90 degrees	19.8 mm	■ ◆ -	
L14351-02	40 kV to 180 kV	0 µA to 500 µA	90 W	20 µm to 200 µm	62 degrees	19.8 mm	• • –	
L15851 ^[4]	90 kV to 130 kV	0 µA to 300 µA	39 W	11 μm (at 8 W) to 25 μm (at 39 W)	166 degrees	0.25 mm	-	
				Open Type				
L10711-03 ⁽³⁾	20 kV to 160 kV	0 µA to 200 µA	8 W Beryllium window	- 0.25 μm*	140 degrees	0.5 mm		
			16 W Diamond window					
L10801 ^[3]	20 kV to 230 kV	0 µA to 1000 µA	200 W	Min. resolution 4 µm	40 degrees	5 mm	• •	
L12721 ^[3]	20 kV to 300 kV	0 μA to 1000 μA at 20 kV to 230 kV	– 200 W	Min. resolution 4 µm	40 degrees to 60 degrees	5 mm		
		0 μA to 500 μA at 231 kV to 300 kV						

^[1] All part no. are available in continuous operation version, L9181 series is also available in pulsed version.

^[2] L9421-02 suitable for off-line inspection. In-line version model available. ^[3] With external control unit.

[4] Transmission type.

* Suitable measurement conditions are necessary.

** Applications								
Micro Computed- Tomography	Lithium-ion Battery Inspection	Materials Analysis	Semiconductor Analysis	Printed Board Circuit Analysis				
•		•		-				

Our X-ray detecting capabilities

X-ray TDI Cameras

These cameras are widely used in in-line inspection because they can continuously acquire high-resolution X-ray images.



C12300 series



Visit our website to see our full range of line scan cameras www.hamamatsu.com



X-ray 2D Flat Panel Sensors

These cameras are widely used in 3D inspection and structural analysis because they irradiate an object with X-rays all at once.



C16401SK-51



Visit our website to see our full range of 2D flat panel sensors



www.hamamatsu.com

Visit our European local offices



HEADQUARTERS

HAMAMATSU PHOTONICS K.K.

325-6, Sunayama-cho, Chuo-ku, Hamamatsu City Shizuoka Pref., 430-8587, Japan Phone: (81)53-452-2141 | Fax: (81)53-456-7889



FRANCE, SWITZERLAND, BELGIUM, SPAIN

HAMAMATSU PHOTONICS FRANCE S.A.R.L. MAIN OFFICE

19, Rue du Saule Trapu, Parc du Moulin de Massy, 91882 Massy Cedex, France Phone: (33)1 69 53 71 00 infos@hamamatsu.fr

SWITZERLAND OFFICE

Dornacherplatz 7, 4500 Solothurn, Switzerland Phone: (41)32-625-60-60 swiss@hamamatsu.ch

BELGIUM OFFICE

Axisparc Technology, Rue Andre Dumont 7 1435 Mont-Saint-Guibert, Belgium Phone: (32)10 45 63 34 info@hamamatsu.be

SPAIN OFFICE

C. Argenters, 4 edif 2 Parque Tecnológico del Vallés 08290 Cerdanyola (Barcelona), Spain Phone: (34)93 582 44 30 infospain@hamamatsu.es

ITALY

HAMAMATSU PHOTONICS ITALIA S.R.L. MAIN OFFICE

Strada della Moia, 1 int. 6, 20044 Arese (Milano), Italy Phone: (39)02-93 58 17 33 info@hamamatsu.it

ROME OFFICE

Viale Cesare Pavese, 435, 00144 Roma, Italy Phone: (39)06-50 51 34 54 inforoma@hamamatsu.it

NORTH EUROPE

HAMAMATSU PHOTONICS NORDEN AB MAIN OFFICE

Torshamnsgatan 35 16440 Kista, Sweden Phone: (46)8-509 031 00 info@hamamatsu.se

DENMARK OFFICE

Lautruphøj 1-3, 2750 Ballerup, Denmark Phone: (45)88-74-53-10 info@hamamatsu.se

UNITED KINGDOM, SOUTH AFRICA

HAMAMATSU PHOTONICS UK LIMITED

MAIN OFFICE

2 Howard Court, 10 Tewin Road, Welwyn Garden City, Hertfordshire AL7 1BW, UK Telephone: (44)1707-294888 info@hamamatsu.co.uk

SOUTH AFRICA CONTACT

9 Beukes Avenue, Highway Gardens, Edenvale 1609 South Africa Telephone: (27)11-609-0367

GERMANY, NETHERLANDS, POLAND, ISRAEL

HAMAMATSU PHOTONICS DEUTSCHLAND GMBH MAIN OFFICE

Arzbergerstr. 10, 82211 Herrsching am Ammersee, Germany Phone: (49)8152-375-0 info@hamamatsu.de

NETHERLANDS OFFICE

Transistorstraat 7, 1322 CJ Almere, The Netherlands Phone: (31)36-5405384 info@hamamatsu.nl

POLAND OFFICE

10 Ciolka Street, 126-127 01-402 Warsaw, Poland Phone: (48)22-646-0016 poland@hamamatsu.de

ISRAEL OFFICE (HAMAMATSU PHOTONICS ISRAEL LTD.)

Ha-Menofim 10 st., third floor, 4672561 Herzliya, Israel info@hamamatsu.co.il

HAMAMATSU PHOTONICS EUROPE

Arzbergerstr. 10, 82211 Herrsching am Ammersee, Germany Phone: (49)8152-375-0 info@hamamatsu.eu

Worldwide organization

Learn more



www.hamamatsu.com

info@hamamatsu.eu

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